

www.vishay.com

Vishay Semiconductors

AUTOMOTIVE

HALOGEN

FREE GREEN

# High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



#### **LINKS TO ADDITIONAL RESOURCES**



#### **DESCRIPTION**

As part of the <u>SurfLight</u><sup>TM</sup> portfolio, the VSMY2941X01 series are infrared, 940 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

### **FEATURES**

Package type: surface-mountPackage form: GW, RGW



• Peak wavelength:  $\lambda_p = 940 \text{ nm}$ 

• AEC-Q101 qualified

High radiant power

· Very high radiant intensity

• Angle of half intensity:  $\varphi = \pm 8^{\circ}$ 

Terminal configurations: gullwing or reverse gullwing

Package matches with detector VEMD2000X01 series

Floor life: 4 weeks, MSL 2a, according to J-STD-020

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- · Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors
- Head-up displays

PRODUCT SUMMARY					
COMPONENT	I <sub>e</sub> (mW/sr)	φ <b>(°)</b>	$\lambda_{\mathbf{P}}$ (nm)	t <sub>r</sub> (ns)	
VSMY2941RGX01	160	± 8	940	5	
VSMY2941GX01	160	± 8	940	5	

#### Note

· Test conditions see table "Basic Characteristics"

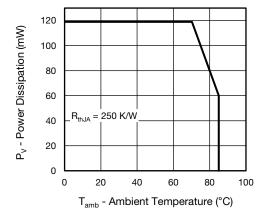
ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMY2941RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing		
VSMY2941GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing		

#### Note

• MOQ: minimum order quantity



<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		$V_{R}$	5	V
Forward current		I <sub>F</sub>	70	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I <sub>FM</sub>	140	mA
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	500	mA
Power dissipation		P <sub>V</sub>	120	mW
Junction temperature		Tj	100	°C
Operating temperature range		T <sub>amb</sub>	-40 to +85	°C
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C
Soldering temperature	According to Fig. 10, J-STD-020	T <sub>sd</sub>	260	°C
Thermal resistance junction to ambient	J-STD-051, soldered on PCB	R <sub>thJA</sub>	250	K/W



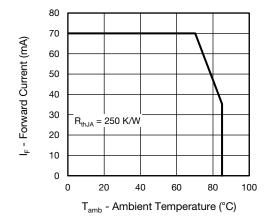


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
	$I_F = 50 \text{ mA}, t_p = 20 \text{ ms}$	$V_{F}$	ı	1.4	1.7	V
Forward voltage	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	$V_{F}$	1	1.5	-	V
	$I_F = 500 \text{ mA}, t_p = 100 \mu \text{s}$	$V_{F}$	-	2.6	-	V
Temperature coefficient of V <sub>F</sub>	I <sub>F</sub> = 50 mA	TK <sub>VF</sub>	-	-0.7	-	mV/K
Reverse current	I <sub>R</sub> Not designed for reverse operati		e operation	μΑ		
Junction capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0 \text{ mW/cm}^2$	CJ	-	30	-	рF
Radiant intensity	$I_F = 50 \text{ mA}, t_p = 20 \text{ ms}$	l <sub>e</sub>	60	115	170	mW/sr
	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	l <sub>e</sub>	-	160	-	mW/sr
	$I_F = 500 \text{ mA}, t_p = 100 \mu \text{s}$	l <sub>e</sub>	-	850	-	mW/sr
Radiant power	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	фe	-	40	-	mW
Temperature coefficient of radiant power	I <sub>F</sub> = 50 mA	TKφ <sub>e</sub>	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 8	-	0
Peak wavelength	I <sub>F</sub> = 50 mA	$\lambda_{p}$	920	940	960	nm
Spectral bandwidth	I <sub>F</sub> = 70 mA	Δλ	-	55	-	nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 70 mA	$TK\lambda_p$	-	0.28	-	nm/K
Rise time	I <sub>F</sub> = 70 mA, 10 % to 90 %	t <sub>r</sub>	-	5	-	ns
Fall time	I <sub>F</sub> = 70 mA, 10 % to 90 %	t <sub>f</sub>	-	6	_	ns

## **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

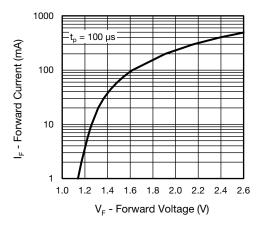


Fig. 3 - Forward Current vs. Forward Voltage

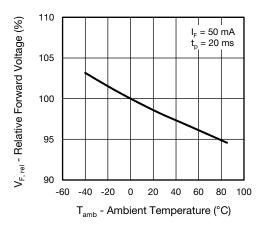


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

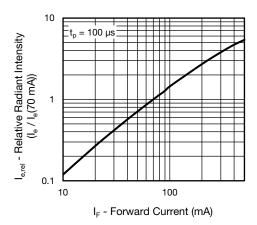


Fig. 5 - Radiant Intensity vs. Forward Current

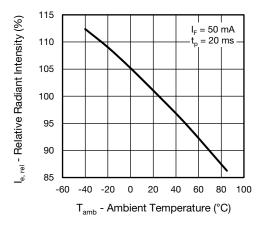


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

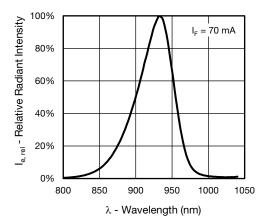


Fig. 7 - Relative Radiant Intensity vs. Wavelength

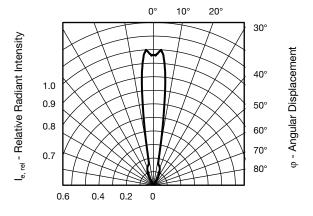


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

#### **SOLDER PROFILE**

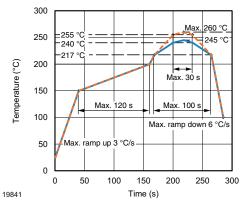


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

#### **DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

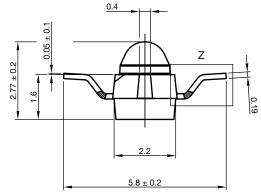
Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

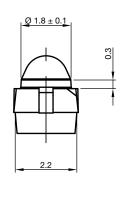
Moisture sensitivity level 2a, according to J-STD-020.

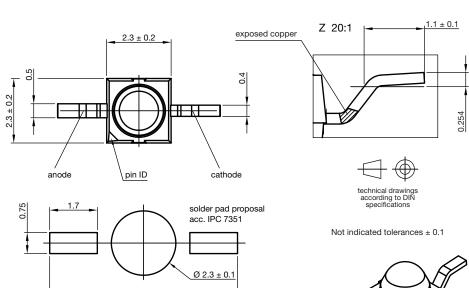
#### **DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

### PACKAGE DIMENSIONS in millimeters: VSMY2941RGX01







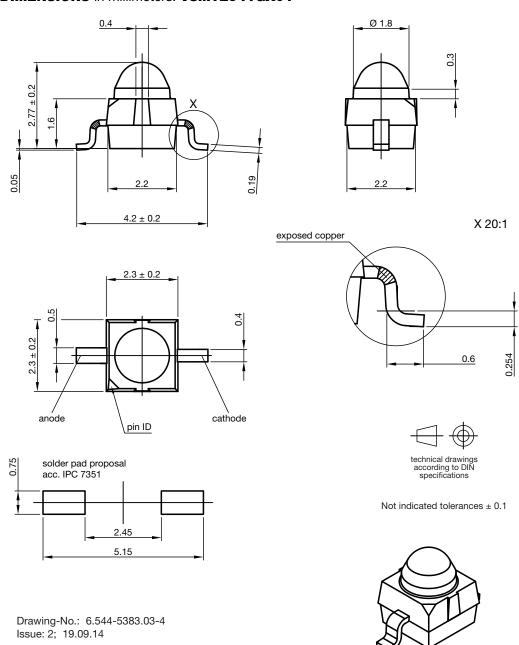
Issue: 2; 19.09.14

Drawing-No.: 6.544-5391.03-4

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

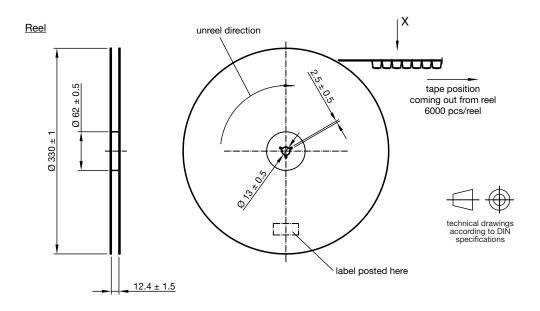
6.7

### PACKAGE DIMENSIONS in millimeters: VSMY2941GX01

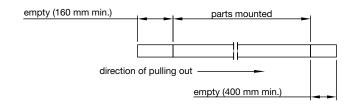


Rev. 1.2, 02-Apr-2025 5 Document Number: 84573

### TAPING AND REEL DIMENSIONS in millimeters: VSMY2941RGX01



#### Leader and trailer tape



#### Terminal position in tape

Device	Lead I	Lead II	
VEMT2000	Collector	Emitter	
VEMT2500	Collector	Emiller	
VEMD2000			
VEMD2500		Anode	
VSMB2000	Cathode		
VSMG2000			
VSMF2890RG			
VSMY2850RG	Anode	Cathode	
VSMY2940RG	Alloue	Callioue	

 $.75 \pm 0.1$ 0.3 12±  $5.5 \pm 0.05$  $3.05 \pm 0.1$ II

 $4 \pm 0.1$ 

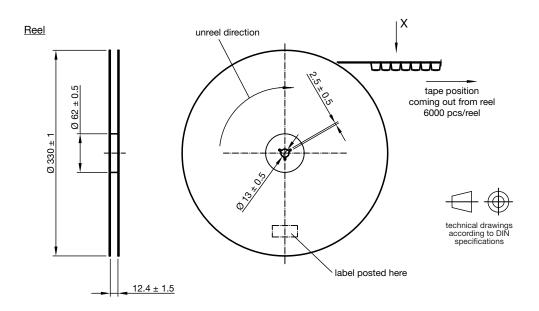
Ø 1.55 ± 0.05

Drawing-No.: 9.800-5100.01-4

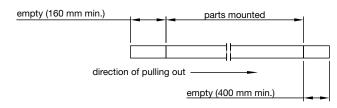
Issue: 4; 19.09.14

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

### TAPING AND REEL DIMENSIONS in millimeters: VSMY2941GX01

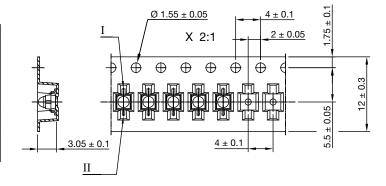


#### Leader and trailer tape



#### Terminal position in tape

Device	Lead I	Lead II	
VSMB2020			
VSMG2020			
VEMD2020	Cathode	Anode	
VEMD2520			
VSMF2890G			
VEMT2020	Collector	Emitter	
VEMT2520	Collector		
VSMY2850G	Anode	Cathode	
VSMY2940G	Anoue	Califode	



Drawing-No.: 9.800-5091.01-4

Issue: 5; 19.09.14



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.